Breakthrough InstaSPIN[™]-FOC motor control technology is here!

🔱 Texas Instruments

InstaSPIN-FOC technology enables designers to identify, tune and fully control any type of three-phase, variable-speed, synchronous or asynchronous motor in just minutes. This new technology removes the need for a mechanical rotor sensor by using TI's new software encoder (sensorless observer) algorithm, FAST[™] (flux, angle, speed and torque), embedded in the read-only-memory (ROM) of Piccolo[™] microcontrollers. This enables premium solutions that improve motor efficiency, performance and reliability in all variable-speed and variable-load applications.

www.ti.com/instaspin-foc



Rotor Flux F · High integrity signal for stable field control **Rotor Angle** · Locks within one electrical cycle of rotation Α

- Stable through zero
- Robust under dynamics
- · Recovery after stall events

Rotor Speed

S

т

- Mechanical and electrical speed estimations
- Near zero phase lag

Rotor Torque

 Accurate for load monitoring, flow rate, unbalanced load, motor diagnostics

FAST[™] Software Encoder (Sensorless Observer)

- Universal 3-phase motor software encoder supports
 - Synchronous (BLDC, SPM, IPM)
 - Asynchronous (ACI) motors
 - Unique, high-quality feedback signals for use in control systems
- Performance
 - Tracks below 1 Hz
 - Tracks through zero on speed reversals
 - Stable feedback to control system when rotor is at zero speed
- Motor parameters
 - Relies on fewer parameters than other observers
 - Off-line commissioning learns the needed electrical motor parameters
 - Optional on-line observer tracks parameter changes to ensure estimation accuracy over time and temperature

FAST[™]Algorithm

Flux

Angle

S peed

Toraue

Tuning

• No tuning of the observer required

Included in ROM on select Piccolo™ MCUs, with software API



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